Unit in mm

TOSHIBA ALLOY-FREE HIGHT SPEED THYRISTOR

SH400R28B

HIGH POWER CONTROL APPLICATIONS

Repetitive Peak Off-State Voltage : V_{DRM} = 1300V

Repetitive Peak Reverse Voltage : V_{RRM}

• Average On-State Current : $I_{T(AV)} = 400A$ • Turn-Off Time : $t_q = 25 \mu s$ (Max.)

• Critical Rate of Rise of On-State Current

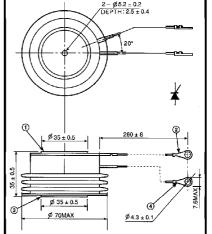
: $di/dt = 200A/\mu s$

• Critical Rate of Rise of Off-State Voltage

: $dv/dt = 500V/\mu s$

• Weight : 480g

Flat Package



1-(1) CATHODE 1-(2) CATHODE (BLACK)

2. ANODE

3. GATE (WHITE)

JEDEC EIAJ

TOSHIBA 13-70E1A

961001EAA

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MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	SYMBOL	RATING	UNIT	
Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage	V _{DRM} V _{RRM}	$v_{ m DRM}$ $v_{ m RRM}$	1300	V	
Non-Repetitive Peak Reverse Voltage (Non-Repetitive $< 5 \text{ms}, T_j = 0 \sim 115 ^{\circ}\text{C}$)	$v_{ m RSM}$	$v_{ m RSM}$	1400	V	
R.M.S On-State Current	IT (RMS)	IT (RMS)	630	Α	
Average On-State Current	I _T (AV)	I _{T (AV)}	400	Α	
Peak One Cycle Surge On-State Current (Non-Repetitive)	ITSM	I _{TSM}	7200 (50Hz) 8000 (60Hz)	A	
I ² t Limit Value	${f I}^2{f t}$	${ m I}^2{ m t}$	200×10^{3}	$\mathrm{A}^2\mathrm{s}$	
Critical Rate of Rise of On-State Current (Note)	di/dt	di/dt	200	A/μs	
Peak Gate Power Dissipation	P_{GM}	P_{GM}	20	W	
Average Gate Power Dissipation	P _G (AV)	P _G (AV)	4	W	
Peak Forward Gate Current	I_{GM}	$I_{\mathbf{GM}}$	4	Α	
Peak Forward Gate Voltage	v_{FGM}	$V_{ extbf{FGM}}$	20	V	
Peak Reverse Gate Voltage	v_{RGM}	v_{RGM}	5	V	
Junction Temperature	T_{j}	T_{j}	-40~115	$^{\circ}\mathrm{C}$	
Storage Temperature Range	$\mathrm{T_{stg}}$	$\mathrm{T_{stg}}$	-40~115	$^{\circ}\mathrm{C}$	
Mounting Force	_	_	14.7 ± 1.5	kN	

ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	TEST CONDITION		MIN.	MAX.	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse Current	IDRM IRRM	$V_{ m DRM} = V_{ m RRM} = { m Rated}$ $T_{ m j} = 115 { m ^{\circ}C}$		_	50	mA
Peak On-State Voltage	$V_{ extbf{TM}}$	$I_{TM} = 1250A, T_j = 25^{\circ}$		2.2	V	
Gate Trigger Voltage	v_{GT}	$V_D = 6V, R_L = 6\Omega$	$T_j = -40^{\circ}C$ $T_j = 25^{\circ}C$	_ _	4.5 3.5	V
Gate Trigger Current	I_{GT}		$T_j = -40^{\circ}C$ $T_j = 25^{\circ}C$		400 260	mA
Gate Non-Trigger Voltage	v_{GD}	$V_D=1/2$ Rated, $T_j=115$ °C		0.2	_	V
Gate Non-Trigger Current	$_{ m IGD}$			5	_	mA
Delay Time	^t d	V _D =1/2 Rated, T _j =25°C Gate Supply		_	4	μs
Gate Turn-On Time	${ m t_{gt}}$	$(V_G=15V, R_G=8\Omega)$	_	6	μ s	
Turn-Off Time	$\mathbf{t_q}$	I_T =800A, V_R \geq 50V dv/dt=20V/ μ s, T_j =110°C V_{DRM} =1/2 Rated		_	25	μs
Holding Current	$I_{ m H}$	$T_j=25$ °C, $R_L=6\Omega$		_	400	mA
Critical Rate of Rise of Off-State Voltage	dv / dt	V _{DRM} =1/2 Rated, 'Gate Open, Exponent	500	_	V/μs	
Thermal Resistance (Junction to Case)	$ m R_{th(j-f)}$	DC			0.05	°C/W

